

产品规格书

SPECIFICATIONS FOR PRODUCT

产品类型 TYPE : HC-49/S

产品规格 SPEC : 24.576MHz/49S/22PF/20PPM

产品型号 P/N : CJ02-245762220A20

日期 DATE : 2021/05/06

| 核准及签名 | | | 番り、フ |
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JSCJ

JIANGSU CHANGJING ELECTRONICS TECHNOLOGY CO., LTD

HC-49/S Quartz Crystal

CJ02-245762220A20

1. Scope:

1.1 This specification applies to the RoHS/SONY compliance quartz crystal unit with a frequency of 24.576MHz which will be used in crystal oscillator applications.

2. Construction:

2.1 Type of Quartz Resonator: HC-49/S

3. Electrical Characteristics

3.1 Nominal Frequency(f): 24.576MHz

3.2 Load Capacitance(C_L): 22pF

3.3 Frequency Tolerance(△f/f): ±20ppm

3.4 Frequency Temperature Stability: ±20ppm(Ref.@25°ℂ)

3.5 Resonance Resistance(ohm): 40ohms Max

3.6 Osc mode: Fundamental mode

3.7 Shunt Capacitance(C_0): <7pF

3.8 Drive Level(D_L): <300 μ W

3.9 Operating Temperature Range(T_{OPR}): -20 to + 70°C

3.10 Storage Temperature Range(T_{STG}): -55 to + 125°C

3.11 Insulation Resistance(IR): >500 M ohms

3.12 Aging($\triangle f_A$): ± 3ppm per Year

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4. Reliability Specifications

This is the quality control and quality assurance and reliability tests performance data for the RoHS/

SONY compliance 24.576MHz HC-49/S Quartz Crystal.

related to the specification and approval sheet provided by JSCJ.

Standard test condition (TEMP.: 20±5°C. Relative humidity: 65±20%)

For any discrepancy in GO/NG, test will be done at TEMP.25±2°C, R.H. 65±5%.

| NO. | PROCESS | SPECIFICATION | TEST METHOD |
|------|---|---|--|
| 4.1 | Temperature Cycle (GB/T 2423.22-2002, Method Nb) | Frequency change after test ≤± 5ppm.Resonance resistance change after test ≤10ohms. | 10 cycles from -55°C to 125°C. Measurement taken after DUT being left at room temperature for 24±2 hours. |
| 4.2 | Low Temperature Storage (GB/T 2423.1-2001, Method Aa) | 5ppm.Resonance resistance change after test ≤10ohms. | Spending 72 hrs at -55°C±3°C constant temperature. Measurement taken after DUT being left at room temperature for 24±2 hours. |
| 4.3 | High Temperature Storage (GB/T 2423.2-2001, Method Ba) | Frequency change after test ≤± 5ppm.Resonance resistance change after test ≤10ohms. | Spending 72 hrs at 125°C±3°C constant temperature. Measurement taken after DUT being left at room temperature for 24±2 hours. |
| 4.4 | Humidity (GB/T 2423.3- 2006, Method Cab) | Frequency change after test ≤± 5ppm.Resonance resistance change after test ≤10ohms. | Spending 96 hrs at 40 °C \pm 3 °C, with 93 %R.H, Then keep the DUT in dry oven at 40 \pm 5 °C for 24 hour. Measurement taken after DUT being left at room temperature for 1 to 2 hours. |
| 4.5 | Vibration (GB/T 2423.10- 1995, Method Fc) | Frequency change after test ≤± 5ppm.Resonance resistance change after test ≤10ohms. | Apply 0.75mm vibration at sweep frequency 10^{\sim} 500 Hz, 10 cycles in each direction of 3 axis. Measurement taken after 1 hour. |
| 4.6 | Shock (GB/T 2423.5-1995, Method Ea) | Frequency change after test ≤± 5ppm.Resonance resistance change after test ≤10ohms.and exhibit no visible damage. | Peak 1000m/s2, normal width 6ms half sine wave form, 3.7m/s, 3 perpendicular axis of samples, 3 cycles / direction, total 18 cycles. Measurement taken after 1 hour. |
| 4.7 | Drop (GB/T 2423.8-1995, Method Ed) | Frequency change after test ≤± 5ppm.Resonance resistance change after test ≤10ohms.and exhibit no visible damage. | Free drop to the steel plate with thickness of 3 mm from 1.00 m heights for 3 times. |
| 4.8 | Solderability (IEC60068-2-58,Test Td:) | Terminals shall be covered more then 95% with solder. | Passed through the re-flow oven under the following condition. Preheat 150 to 180°C for 60 to 120sec, and soldering time for 20s ± 5s at 235°C, peak soldering time for 10s ± 1s betweein 240 and 250°C. There is no need to do functional test. 8-12X magnifier. |
| 4.9 | Terminal Strength (JIS-C-6429 Method 1 & 2) | No visible damage | Mount on a glass-epoxy board (100x50x1.6mm), then bend to 2mm displacement (velocity 1mm/sec) and keep for 5 seconds. or pulling force 1.8kg for at least 60 seconds. |
| 4.10 | Resistance to Soldering Heat (IEC60068-2-58,Test Td: Table 4) | Frequency change after test ≤± 5ppm.Resonance resistance change after test ≤10ohms. | Passed through the re-flow oven under the following condition. Preheat 150 to 180°C for 60 to 120sec, and sodering time for 60s max at 235°C, peak soldering time for 20s max at 265°C max. Measurement taken after DUT being left at room temperature for at least 2 hours. |
| | | | |
| 4.11 | OTHERS | | |

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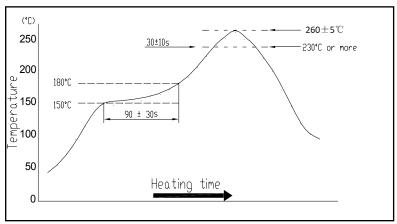
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Recommended Reflow soldering condition

5. Recommended Reflow soldering condition (SMD)

Solder profile

Peak: 260±5°C Soldering zone: 230°C or more, 30±10s. Pre-heating zone 1: 150 \sim 180°C, 90±30s



Temperature profile for reflow soldering

6. Soldering iron method

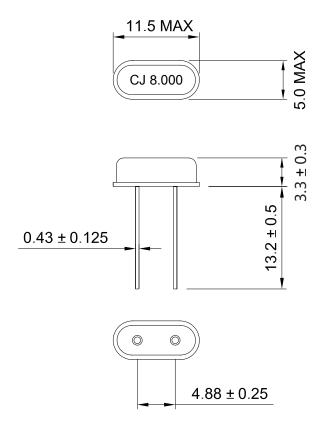
Bit temperature: $350\pm10^{\circ}$ C Application time of soldering iron:3+1 s. For other procedures, refer to IEC 60068-2-20.

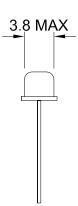
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Package Outline Dimensions

Units:mm





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